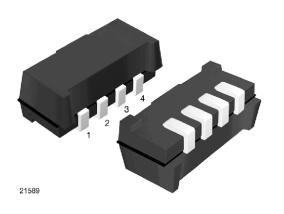
Vishay Semiconductors

IR Receiver Modules for Remote Control Systems



DESIGN SUPPORT TOOLS

click logo to get started



MECHANICAL DATA

Pinning: 1, 4 = GND, 2 = V_S, 3 = OUT

ORDERING CODE EXAMPLE:

Taping:

TSOP77...WTT - top view taped TSOP77...WTR - side view taped

FEATURES

- Improved immunity against HF and RF noise
- Continuous data transmission possible
- Low supply current
- Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.5 V to 5.5 V
- · Improved immunity against ambient light
- · Capable of side or top view
- Insensitive to supply voltage ripple and noise
- Low profile 2.35 mm
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

The TSOP773..W, TSOP775..W series are miniaturized receiver module for infrared remote control systems. One PIN diode per lens and a preamplifier are assembled on a leadframe, the epoxy lens cap contains an IR filter.

The TSOP773..W series devices are optimized to suppress almost all spurious pulses from Wi-Fi and CFL sources. They may suppress some data signals if continuously transmitted.

New designs should prefer the TSOP773..W series containing the newer AGC3. The TSOP775..W series are useful to suppress even extreme levels of optical noise, but may also suppress some data signals. Please check compatibility with your codes.

These components have not been qualified according to automotive specifications.

PARTS TABLE				
AGC		NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3)	VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5)	
	30 kHz	TSOP77330W	TSOP77530W	
	33 kHz	TSOP77333W	TSOP77533W	
Carrier	36 kHz	TSOP77336W ⁽¹⁾	TSOP77536W	
frequency	38 kHz	TSOP77338W ⁽²⁾⁽³⁾⁽⁴⁾⁽⁵⁾	TSOP77538W	
	40 kHz	TSOP77340W	TSOP77540W	
	56 kHz	TSOP77356W	TSOP77556W	
Package		Heimdall no lens		
Pinning		1, 4 = GND, 2 = V _S , 3 = OUT		
Dimensions (mm)		6.8 W x 3.0 H x 2.35 D		
Mounting		SMD		
Application		Remote control		
Best choice for		⁽¹⁾ MCIR ⁽²⁾ Mitsubishi ⁽³⁾ RECS-80 Code ⁽⁴⁾ r-map ⁽⁵⁾ XMP-1, XMP-2		

Rev. 1.7, 26-Apr-2018

1



RoHS

COMPLIANT

HALOGEN

GREEN

(5-2008)

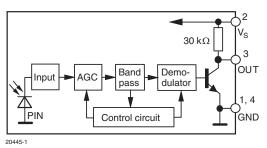




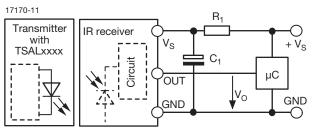


Vishay Semiconductors

BLOCK DIAGRAM



APPLICATION CIRCUIT



 R_1 and C_1 recommended to reduce supply ripple for $V_S < 2.8$ V

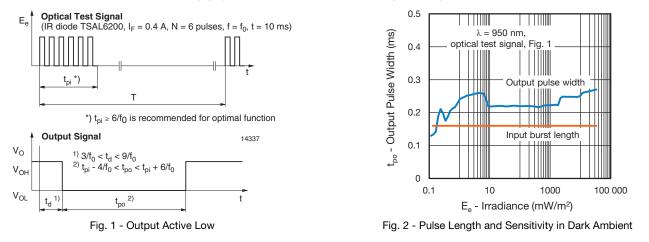
ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		Vs	-0.3 to +6	V
Supply current		I _S	5	mA
Output voltage		Vo	-0.3 to 5.5	V
Voltage at output to supply		V _S - V _O	-0.3 to (V _S + 0.3)	V
Output current		I _O	5	mA
Junction temperature		Тj	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW
Soldering temperature	$t \le 10$ s, 1 mm from case	T _{sd}	260	°C

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

ELECTRICAL AND OPTICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		Vs	2.5	-	5.5	V
Supply surrent	$V_{\rm S} = 5 V, E_{\rm v} = 0$	I _{SD}	0.55	0.7	0.9	mA
Supply current	$E_v = 40$ klx, sunlight	I _{SH}	-	0.8	-	mA
Transmission distance	$E_v = 0$, IR diode TSAL6200, I _F = 250 mA, test signal see Fig. 1	d	-	40	-	m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2$, test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Pulse width tolerance: t_{pi} - 5/f _o < t_{po} < t_{pi} + 6/f _o , test signal see Fig. 1	E _{e min.}	-	0.4	0.8	mW/m ²
Maximum irradiance	t_{pi} - 5/f _o < t_{po} < t_{pi} + 6/f _o , test signal see Fig. 1	E _{e max.}	50	-	-	W/m ²
Directivity	Angle of half transmission distance	φ1/2	-	± 75	-	deg

TYPICAL CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)



Rev. 1.7, 26-Apr-2018

Document Number: 82467

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



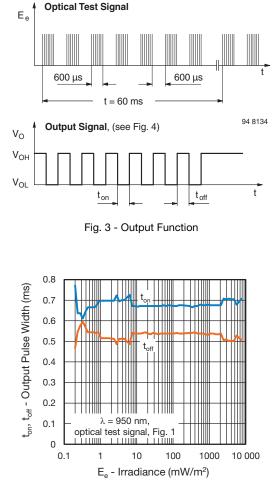


Fig. 4 - Output Pulse Diagram

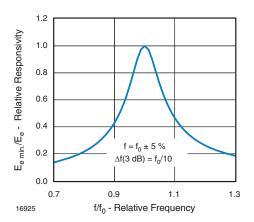


Fig. 5 - Frequency Dependence of Responsivity

Vishay Semiconductors

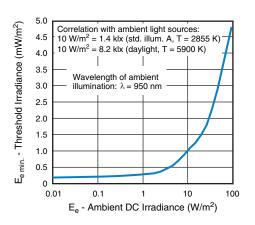


Fig. 6 - Sensitivity in Bright Ambient

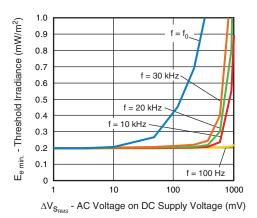


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

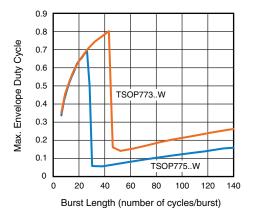


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

Rev. 1.7, 26-Apr-2018



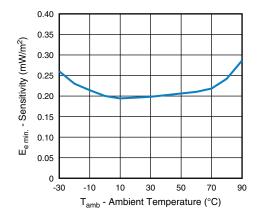


Fig. 9 - Sensitivity vs. Ambient Temperature

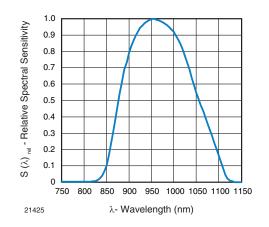


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

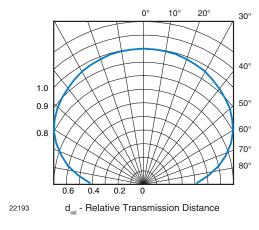


Fig. 11 - Horizontal Directivity

Vishay Semiconductors

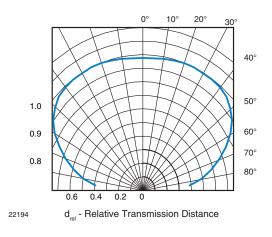


Fig. 12 - Vertical Directivity

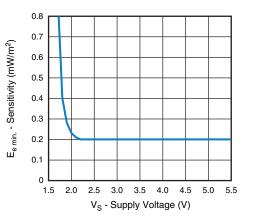


Fig. 13 - Sensitivity vs. Supply Voltage





SUITABLE DATA FORMAT

These products are designed to suppress spurious output pulses due to noise or disturbance signals. Data and disturbance signals can be distinguished by the devices according to carrier frequency, burst length and envelope duty cycle. The data signal should be close to the band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the IR receiver in the presence of a disturbance signal, the sensitivity of the receiver is reduced to insure that no spurious pulses are present at the output. Some examples of disturbance signals which are suppressed are:

- DC light (e.g. from tungsten bulb or sunlight)
- · Continuous signals at any frequency
- Modulated IR signals from common fluorescent lamps (example of noise pattern is shown in Fig. 14 or Fig. 15)
- 2.4 GHz and 5 GHz Wi-Fi

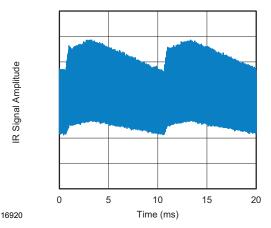


Fig. 14 - IR Disturbance from Fluorescent Lamp With Low Modulation

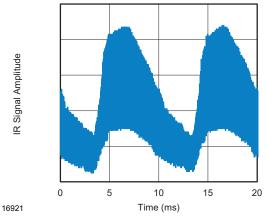


Fig. 15 - IR Disturbance from Fluorescent Lamp With High Modulation

	TSOP773W	TSOP775W
Minimum burst length	6 cycles/burst	6 cycles/burst
After each burst of length a minimum gap time is required of	6 to 35 cycles ≥ 10 cycles	6 to 24 cycles ≥ 10 cycles
For bursts greater than	35 cycles	24 cycles
a minimum gap time in the data stream is needed of	> 4 x burst length	> 25 ms
Maximum number of continuous short bursts/second	2000	2000
MCIR code	Preferred	Yes
XMP-1, XMP-2, code	Preferred	Yes
Suppression of interference from fluorescent lamps	Mild and complex disturbance patterns are suppressed (example: signal pattern of Fig. 14 and Fig. 15)	Critical disturbance patterns are suppressed, e.g. highly dimmed LCDs

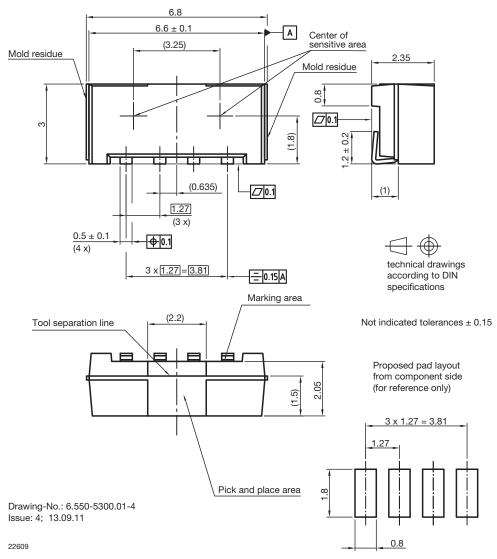
Note

· For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP772..W, TSOP774..W



Vishay Semiconductors

PACKAGE DIMENSIONS in millimeters



ASSEMBLY INSTRUCTIONS

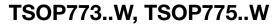
Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

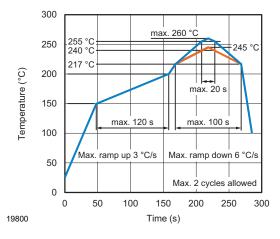
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- · Handle products only after the temperature has cooled off

Rev. 1.7, 26-Apr-2018

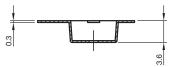


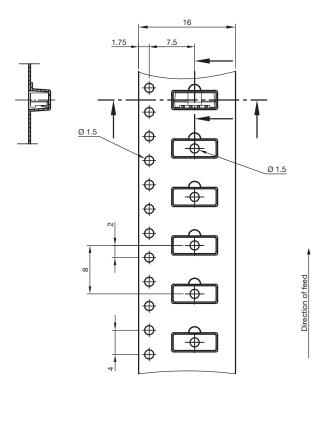


VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSOP..TR DIMENSIONS in millimeters





technical drawings according to DIN specifications

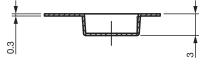
Drawing-No.: 9.700-5342.01-4 Issue: 2; 12.06.13

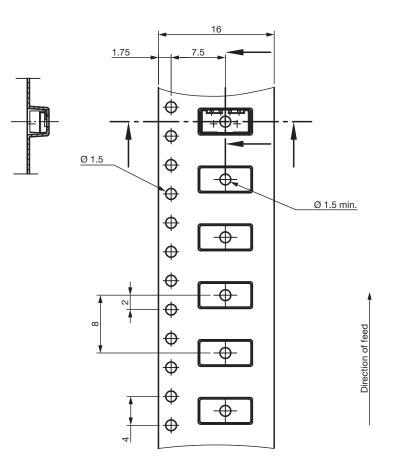
Rev. 1.7, 26-Apr-2018

Document Number: 82467



TAPING VERSION TSOP..TT DIMENSIONS in millimeters





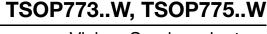


technical drawings according to DIN specifications

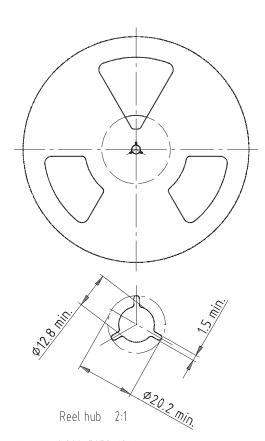
Drawing-No.: 9.700-5341.01-4 Issue: 3; 06.10.15

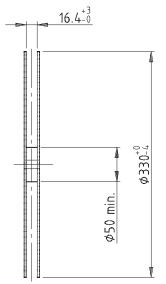


REEL DIMENSIONS in millimeters



Vishay Semiconductors





Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

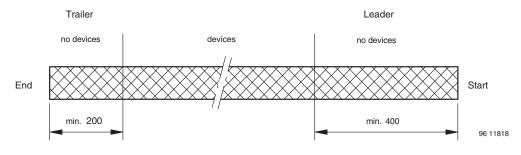
Tape width 16



technical drawings according to DIN specifications

Drawing-No.: 9.800-5052.V2-4 Issue: 1; 07.05.02

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

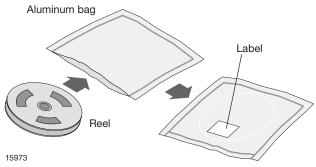
Rev. 1.7, 26-Apr-2018



VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)			
PLAIN WRITING	ABBREVIATION	LENGTH	
Item-description	-	18	
Item-number	INO	8	
Selection-code	SEL	3	
LOT-/serial-number	BATCH	10	
Data-code	COD	3 (YWW)	
Plant-code	PTC	2	
Quantity	QTY	8	
Accepted by	ACC	-	
Packed by	PCK	-	
Mixed code indicator	MIXED CODE	-	
Origin	xxxxxx+	Company logo	
Long bar code top	Туре	Length	
Item-number	Ν	8	
Plant-code	Ν	2	
Sequence-number	Х	3	
Quantity	Ν	8	
Total length	-	21	
Short bar code bottom	Туре	Length	
Selection-code	Х	3	
Data-code	Ν	3	
Batch-number	Х	10	
Filter	-	1	
Total length	-	17	

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 $^{\circ}\text{C}$ + 5 $^{\circ}\text{C}$ and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard J-STD-020 level 4 label is included on all dry bags.

CAUTION This bag contains MOISTURE-SENSITIVE DEVICES	s 4			
1. Shelf life in sealed bag: 12 months at < 40 °C and < 90 % humidity (RH)	6 relative			
 After this bag is opened, devices that will be subjected to soldering reflow or equivalent processing (peak package body temp. 260 °C) must be Mounted within 72 hours at factory condition of < 30 °C/60 % RH or 50 Stored at < 5 % RH 				
 Devices require baking befor mounting if: Humidity Indicator Card is > 10 % when read at 23 °C ± 2a. or 2b. are not met. 	5 °C or			
4. If baking is required, devices may be baked for: 192 hours at 40 °C + 5 °C/- 0 °C and < 5 % RH (dry air/ 96 hours at 60 °C ± 5 °C and < 5 % RH for all device or 24 hours at 125 °C ± 5 °C not suitable for reels or tubes	ontainers or			
Bag Seal Date: (If blank, see barcode label)				
Note: Level and body temperature defined by EIA JEDEC Stand	lard J-STD-02			

EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

Rev. 1.7, 26-Apr-2018



Vishay Semiconductors

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

BAR CODE PRODUCT LABEL (example)





Tape and Reel Standards for Surface-Mount IR Receiver Modules

Vishay Semiconductor surface-mount IR receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Туре
- Group
- Tape code, normally part of type name
- Production code
- Quantity

MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

Tensile strength of the tape: > 15 N

NUMBER OF COMPONENTS

- A. Panhead: quantity per reel:
 TT, top view package, 1190 pcs
 TR, side view package, 1120 pcs
- B. Heimdall: quantity per reel:
 TT, top view package, 2200 pcs
 TR, side view package, 2300 pcs
- C. Heimdall without lens: quantity per reel: WTT, top view package, 2200 pcs WTR, side view package, 2300 pcs
- D. Belobog: quantity per reel: TT1, top view package, 1800 pcs
- E. Belobog with shield: quantity per reel: TT1, top view package, 1500 pcs
- F. Minimold DF1P: quantity per reel: DF1P, 1100 pcs
- G. TVCastSMD TR1: quantity per reel: TR1, side view package, 2000 pcs

ORDER DESIGNATION

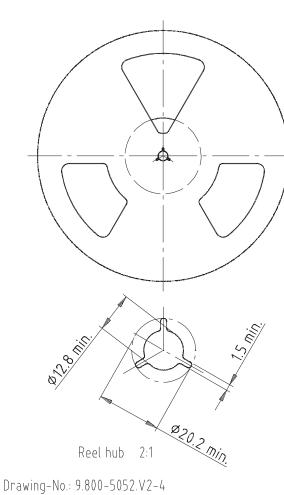
The type designation of the device is extended by TT or TT1 for top view or TR for side view.

Example:

TSOP6238TR (reel packing) TSOP75238TR (reel packing) TSOP75338WTT (reel packing) TSOP57438TT1 (reel packing) TSOP57238HTT1 (reel packing) TSOP39438TR1 (reel packing)



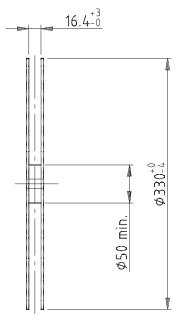
REEL DIMENSIONS FOR PANHEAD, HEIMDALL, AND TVCASTSMD TR in millimeters



Issue: 1; 07.05.02

Note

• The body structure of the reel can vary



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16



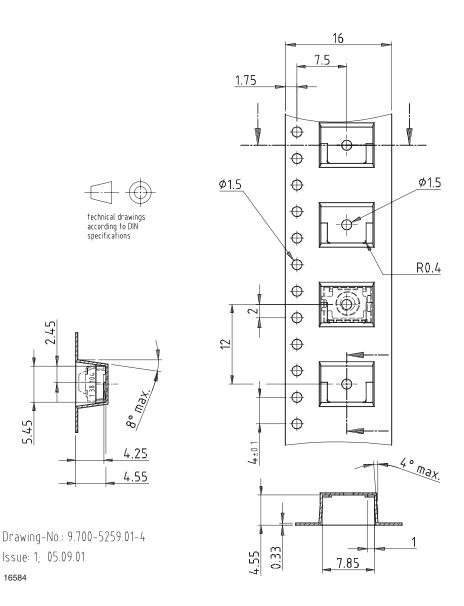
technical drawings according to DIN specifications

Rev. 2.5, 08-Mar-18



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

A. Panhead (TSOP36...TT, TSSP....TT, TSOP6...TT, TSOP16...TT, TSOP96...TT)

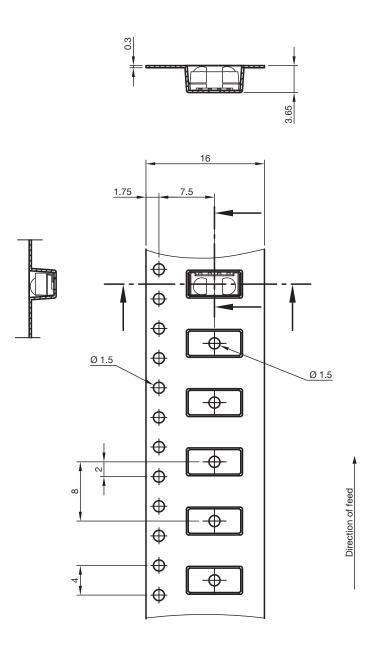


www.vishay.com

Vishay Semiconductors

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

B. Heimdall (TSOP75...TT, TSOP77...TT, TSSP77...TT, TSOP15...TT, TSOP95...TT)





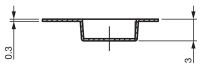
technical drawings according to DIN specifications

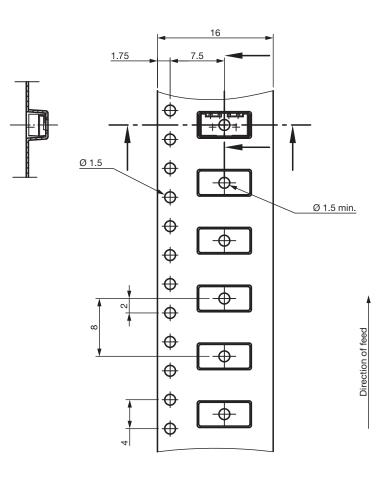
Drawing-No.: 9.700-5338.01-4 Issue: 4; 12.06.13



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTT, TSOP77...WTT, TSSP77...WTT, TSOP15...WTT, TSOP95...WTT)







technical drawings according to DIN specifications

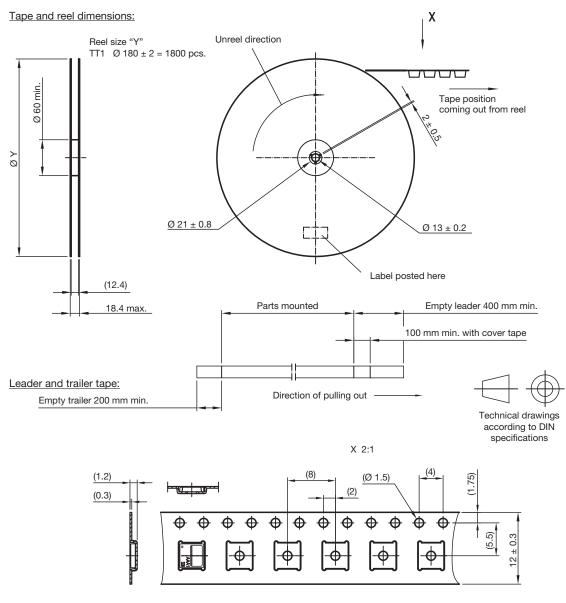
Drawing-No.: 9.700-5341.01-4 Issue: 3; 06.10.15

TAPING VERSION TSOP..TT1 (TOP VIEW) DIMENSIONS in millimeters

D. Belobog (TSOP37...TT1, TSOP57...TT1, TSOP17...TT1, TSOP97...TT1)

www.vishay.com

'ISHA)



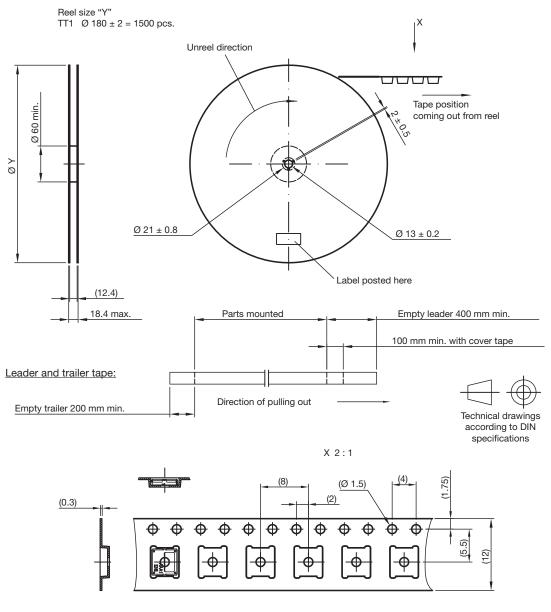
Drawing-No.: 9.700-5347.01-4 Issue: 2; 07.03.18 Not indicated tolerances ± 0.1



TAPING VERSION TSOP..TT1 (TOP VIEW) DIMENSIONS in millimeters

E. Belobog with shield (TSOP37...HTT1, TSOP57...HTT1, TSOP17...HTT1, TSOP97...HTT1)

Tape and reel dimensions:



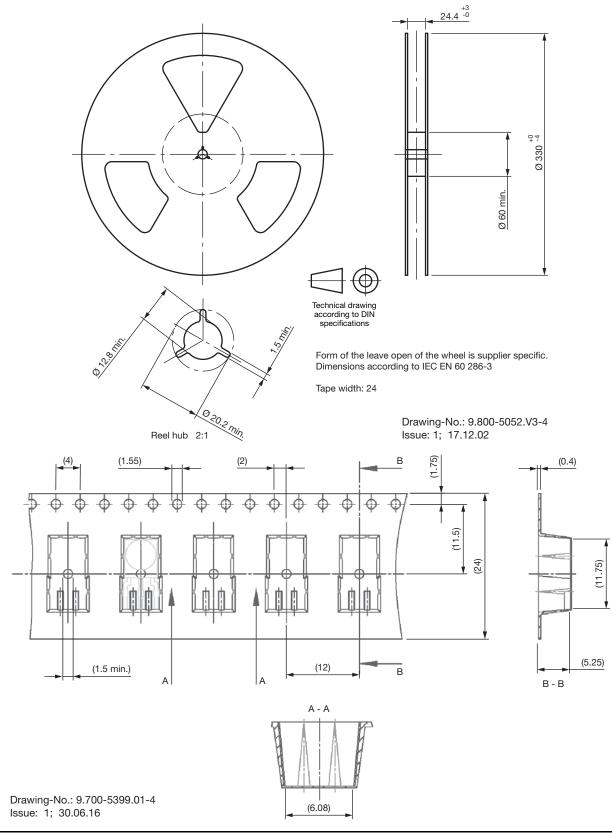
Drawing-No.: 9.700-5380.01-4 Issue: 3; 07.03.18 Not indicated tolerances $\pm \ 0.1$

WISHAY www.vishay.com

Vishay Semiconductors

TAPING VERSION TSOP...DF1P (SIDE VIEW) DIMENSIONS in millimeters

F. Minimold DF1P (TSOP33...DF1P, TSOP53...DF1P, TSOP13...DF1P, TSOP93...DF1P)



Rev. 2.5, 08-Mar-18

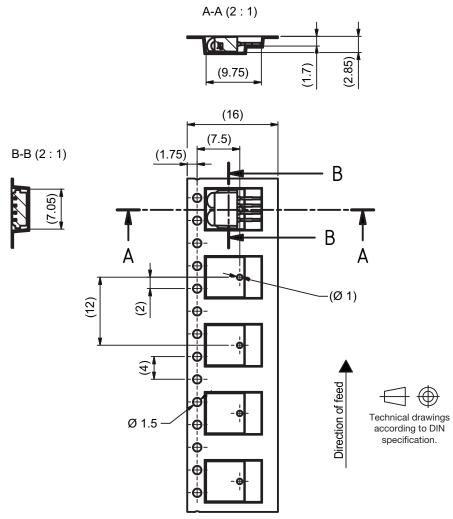
8

Document Number: 80125



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

G. TVCastSMD TR1 (TSOP59...TR1, TSOP39...TR1, TSOP19...TR1, TSOP99...TR1)

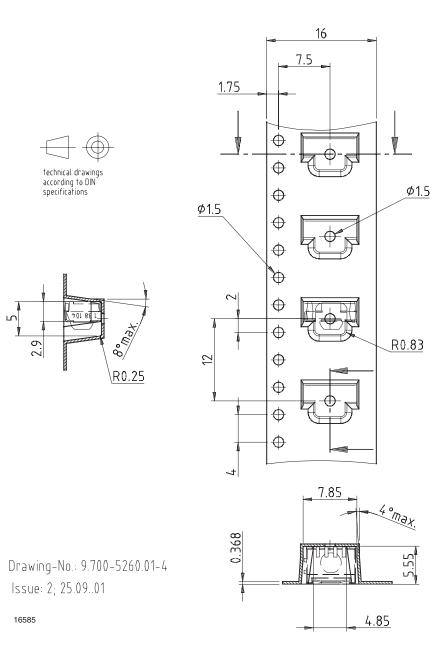


Drawing-No.: GO-100220.10_Z Issue B: 08.02.17

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

A. Panhead (TSOP36...TR, TSSP6...TR, TSOP6...TR, TSOP16...TR, TSOP96...TR)

www.vishay.com

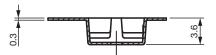


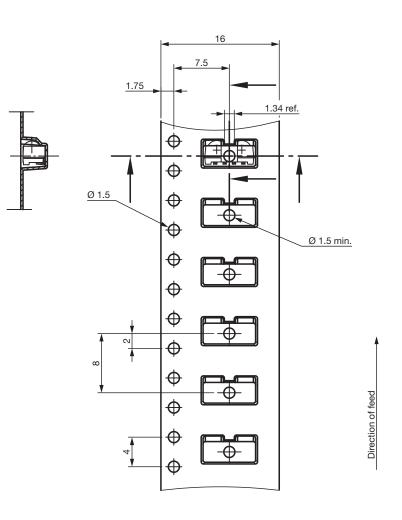
VISHAY



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall (TSSP7...., TSOP75...TR, TSOP77...TR, TSSP7....TR, TSOP15...TR, TSOP95...TR)





 $\ominus \oplus$

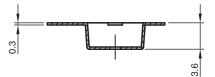
technical drawings according to DIN specifications

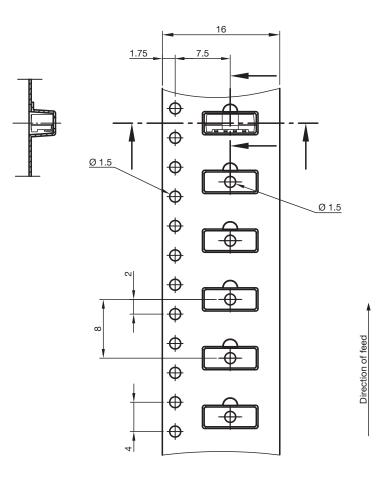
Drawing-No.: 9.700-5337.01-4 Issue: 2; 06.10.15



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTR, TSOP77...WTR, TSSP...WTR, TSOP15...WTR, TSOP95...WTR)





 $\ominus \oplus$

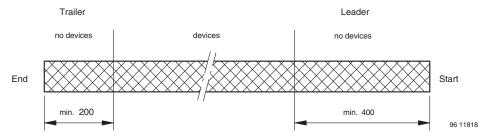
technical drawings according to DIN specifications

Drawing-No.: 9.700-5342.01-4 Issue: 2; 12.06.13





LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE REEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. \pm 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

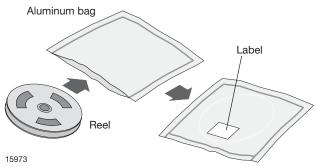
VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)			
PLAIN WRITING	ABBREVIATION	LENGTH	
Item-description	-	18	
Item-number	INO	8	
Selection-code	SEL	3	
LOT-/serial-number	BATCH	10	
Data-code	COD	3 (YWW)	
Plant-code	PTC	2	
Quantity	QTY	8	
Accepted by	ACC	-	
Packed by	PCK	-	
Mixed code indicator	MIXED CODE	-	
Origin	XXXXXXX+	Company logo	
LONG BAR CODE TOP	ТҮРЕ	LENGTH	
Item-number	Ν	8	
Plant-code	Ν	2	
Sequence-number	Х	3	
Quantity	Ν	8	
Total length	-	21	
SHORT BAR CODE TOP	ТҮРЕ	LENGTH	
Selection-code	Х	3	
Data-code	Ν	3	
Batch-number	Х	10	
Filter	-	1	
Total length	-	17	

Rev. 2.5, 08-Mar-18



DRY PACKAGING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 $^\circ\text{C}$ + 5 $^\circ\text{C}$ and < 5 % RH for all device containers or

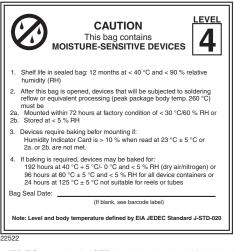
24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard JSTD-020 level 4 label is included on all dry bags.

OUTER PACKAGING

The sealed reel is packed into a pizza box.

Vishay Semiconductors



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

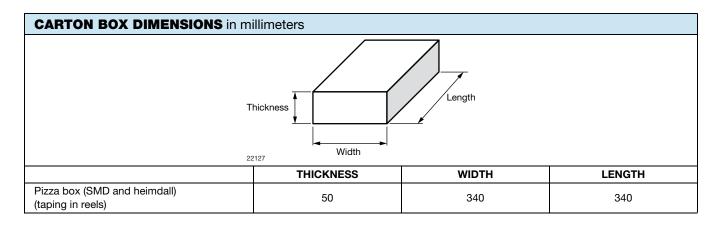
ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.





Rev. 2.5, 08-Mar-18

Document Number: 80125



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.